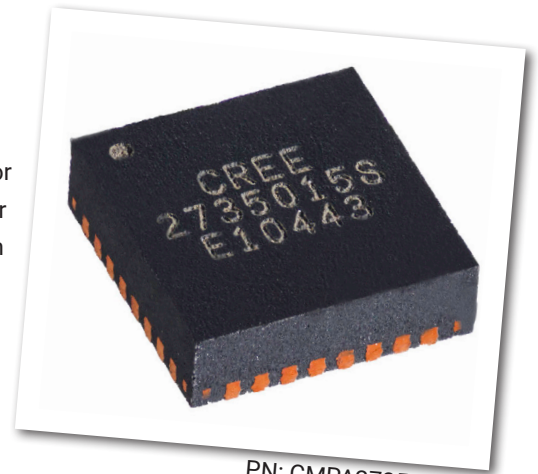


# CMPA2735015S

## 15 W, 2.7 - 3.5 GHz, GaN MMIC, Power Amplifier

Cree's CMPA2735015S is a gallium nitride (GaN) High Electron Mobility Transistor (HEMT) based monolithic microwave integrated circuit (MMIC). GaN has superior properties compared to silicon or gallium arsenide, including higher breakdown voltage, higher saturated electron drift velocity and higher thermal conductivity. GaN HEMTs also offer greater power density and wider bandwidths compared to Si and GaAs transistors. This MMIC contains a two-stage reactively matched amplifier design approach enabling high power and power added efficiency to be achieved in a 5mm x 5mm, surface mount (QFN package).



PN: CMPA2735015S

### Typical Performance Over 2.7-3.5 GHz ( $T_c = 25^\circ\text{C}$ )

Parameter	2.7 GHz	2.9 GHz	3.1 GHz	3.3 GHz	3.5 GHz	Units
Small Signal Gain	35	34	34	34	33	dB
Saturated Output Power	21	21	24	25	22	W
Power Gain	27.3	27.2	27.9	27.9	27.5	dB
PAE	56	53	49	48	50	%

Note:  $P_{IN} = 16$  dBm, Pulse Width = 500  $\mu\text{s}$ ; Duty Cycle = 10%

### Features

- 33 dB Small Signal Gain
- 21 W Typical  $P_{SAT}$
- Operation up to 50 V
- High Breakdown Voltage
- High Temperature Operation
- 5 mm x 5 mm Total Product Size

### Applications

- Civil and Military Pulsed Radar Amplifiers



Figure 1.



## Absolute Maximum Ratings (not simultaneous) at 25°C

Parameter	Symbol	Rating	Units	Conditions
Drain-source Voltage	$V_{DSS}$	150	VDC	25°C
Gate-source Voltage	$V_{GS}$	-10, +2	VDC	25°C
Storage Temperature	$T_{STG}$	-65, +150	°C	
Operating Junction Temperature	$T_J$	225	°C	
Maximum Forward Gate Current	$I_G$	3	mA	25°C
Screw Torque	T	40	in-oz	
Thermal Resistance, Junction to Case (packaged)	$R_{\theta JC}$	TBD	°C/W	300 μsec, 20%, 85°C
Thermal Resistance, Junction to Case (packaged)	$R_{\theta JC}$	TBD	°C/W	CW, 85°C

## Electrical Characteristics (Frequency = 2.9 GHz to 3.5 GHz unless otherwise stated; $T_c = 25^\circ\text{C}$ )

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
<b>DC Characteristics</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	-3.8	-3.0	-2.3	V	$V_{DS} = 10\text{ V}, I_D = 3\text{ mA}$
Gate Quiescent Voltage	$V_{GS(Q)}$	-	-2.7	-	$V_{DC}$	$V_{DD} = 50\text{ V}, I_{DQ} = 80\text{ mA}, \text{Freq} = 2.9\text{ GHz}$
Saturated Drain Current <sup>1</sup>	$I_{DS}$	-	3	-	A	$V_{DS} = 6.0\text{ V}, V_{GS} = 2.0\text{ V}$
Drain-Source Breakdown Voltage	$V_{BD}$	-	150	-	V	$V_{GS} = -8\text{ V}, I_D = 3\text{ mA}$
<b>RF Characteristics<sup>2,3</sup></b>						
Small Signal Gain <sub>1</sub>	S21	-	35	-	dB	$V_{DD} = 50\text{ V}, I_{DQ} = 80\text{ mA}, \text{Freq} = 2.7\text{ GHz}$
Small Signal Gain <sub>2</sub>	S21	-	34	-	dB	$V_{DD} = 50\text{ V}, I_{DQ} = 80\text{ mA}, \text{Freq} = 3.1\text{ GHz}$
Small Signal Gain <sub>3</sub>	S21	-	33	-	dB	$V_{DD} = 50\text{ V}, I_{DQ} = 80\text{ mA}, \text{Freq} = 3.5\text{ GHz}$
Power Output <sub>1</sub>	$P_{OUT}$	-	21	-	W	$V_{DD} = 50\text{ V}, I_{DQ} = 80\text{ mA}, P_{IN} = 16\text{ dBm}, \text{Freq} = 2.7\text{ GHz}$
Power Output <sub>2</sub>	$P_{OUT}$	-	24	-	W	$V_{DD} = 50\text{ V}, I_{DQ} = 80\text{ mA}, P_{IN} = 16\text{ dBm}, \text{Freq} = 3.1\text{ GHz}$
Power Output <sub>3</sub>	$P_{OUT}$	-	22	-	W	$V_{DD} = 50\text{ V}, I_{DQ} = 80\text{ mA}, P_{IN} = 16\text{ dBm}, \text{Freq} = 3.5\text{ GHz}$
Power Added Efficiency <sub>1</sub>	PAE	-	56	-	%	$V_{DD} = 50\text{ V}, I_{DQ} = 80\text{ mA}, \text{Freq} = 2.7\text{ GHz}$
Power Added Efficiency <sub>2</sub>	PAE	-	49	-	%	$V_{DD} = 50\text{ V}, I_{DQ} = 80\text{ mA}, \text{Freq} = 3.1\text{ GHz}$
Power Added Efficiency <sub>3</sub>	PAE	-	50	-	%	$V_{DD} = 50\text{ V}, I_{DQ} = 80\text{ mA}, \text{Freq} = 3.5\text{ GHz}$
Power Gain	$G_p$	-	27	-	dB	$V_{DD} = 50\text{ V}, I_{DQ} = 80\text{ mA}$
Input Return Loss	S11	-	-8	-	dB	$V_{DD} = 50\text{ V}, I_{DQ} = 80\text{ mA}$
Output Return Loss	S22	-	-7	-	dB	$V_{DD} = 50\text{ V}, I_{DQ} = 80\text{ mA}$
Output Mismatch Stress	VSWR	-	-	5 : 1	Ψ	No damage at all phase angles, $V_{DD} = 50\text{ V}, I_{DQ} = 80\text{ mA}, P_{OUT} = 15\text{ W Pulsed}$

### Notes:

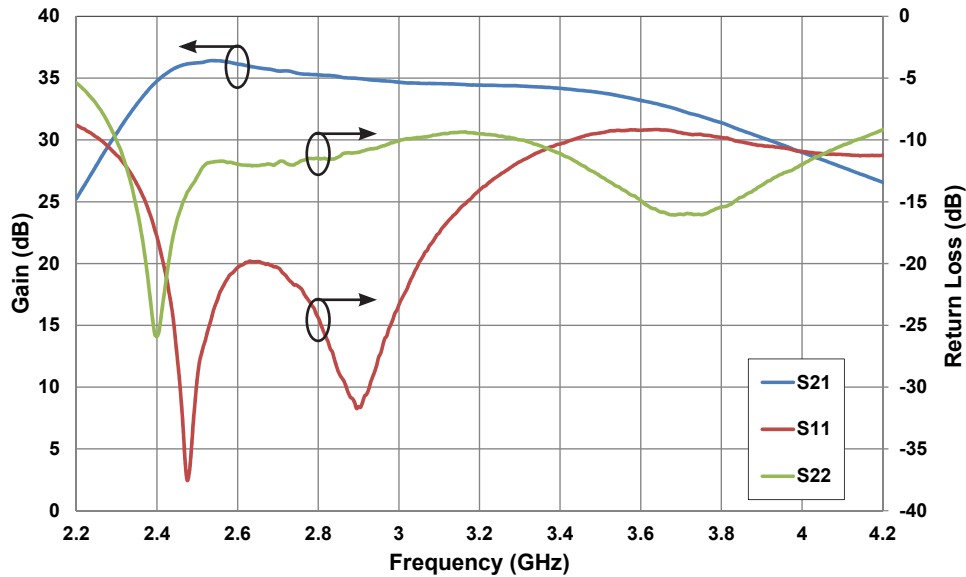
<sup>1</sup> Scaled from PCM data.

<sup>2</sup> All data tested in CMPA2735015S-AMP1

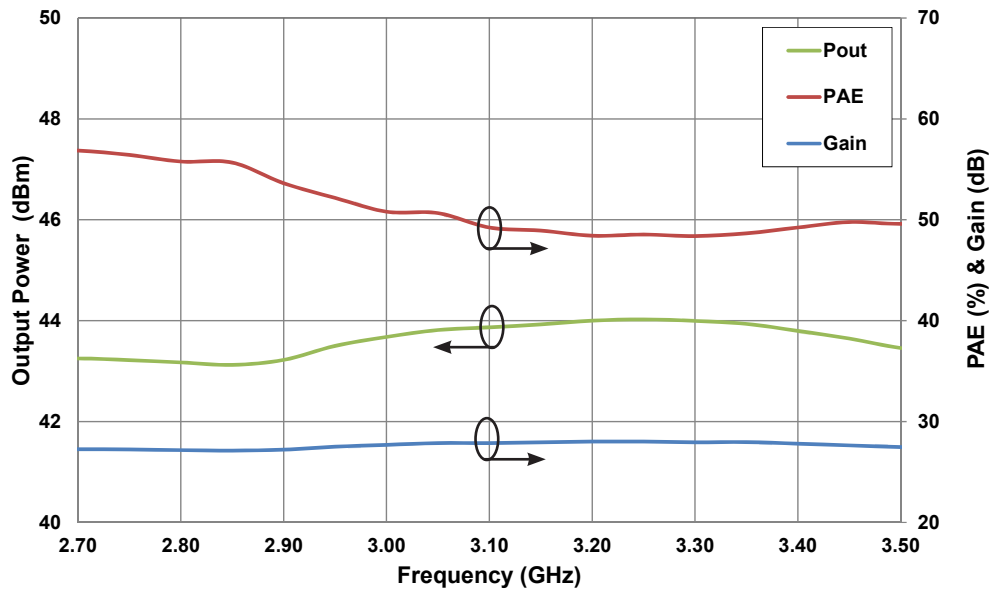
<sup>3</sup> Pulse Width = 500 μs; Duty Cycle = 10%

## Typical Performance of the CMPA2735015S

**Figure 1. - Gain and Return Loss vs Frequency of the CMPA2735015S  
Measured in CMPA2735015S-AMP1 Amplifier Circuit  
 $V_{DD} = 50\text{ V}$ ,  $I_{DQ} = 0.08\text{ A}$**

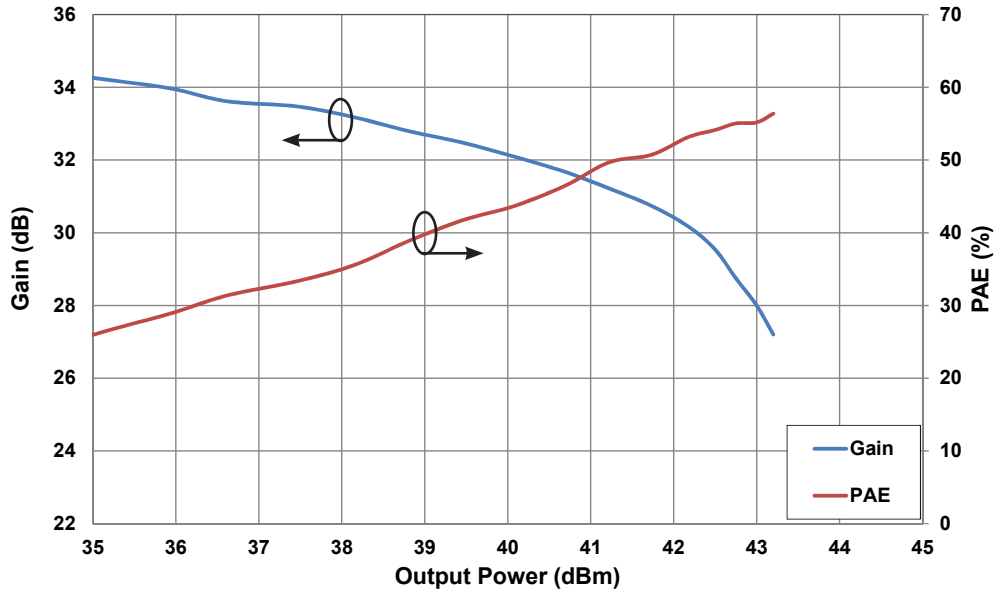


**Figure 2. - Output Power, Gain and PAE vs Frequency of the CMPA2735015S  
Measured in CMPA2735015S-AMP1 Amplifier Circuit.  
 $V_{DD} = 50\text{ V}$ ,  $I_{DQ} = 0.08\text{ A}$ , Pulse Width =  $500\text{ }\mu\text{S}$ , Duty Cycle = 10%**

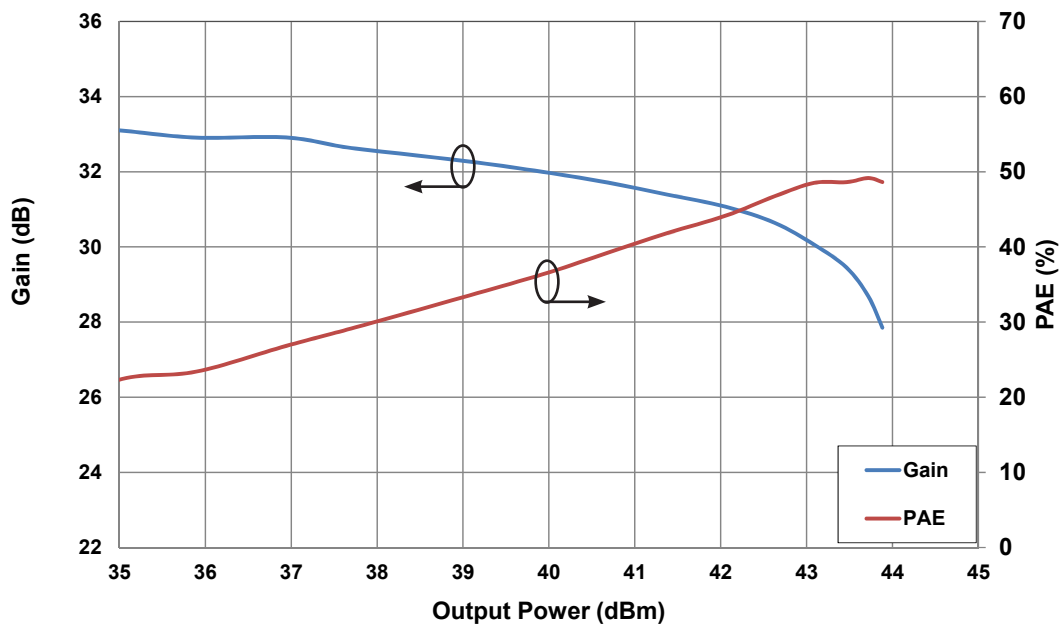


## Typical Performance of the CMPA2735015S

**Figure 3. - Gain and Power Added Efficiency vs Output Power  
Measured in CMPA2735015S-AMP1 Amplifier Circuit  
 $V_{DD} = 50\text{ V}$ ,  $I_{DQ} = 0.08\text{ A}$ , Frequency = 2.7 GHz**

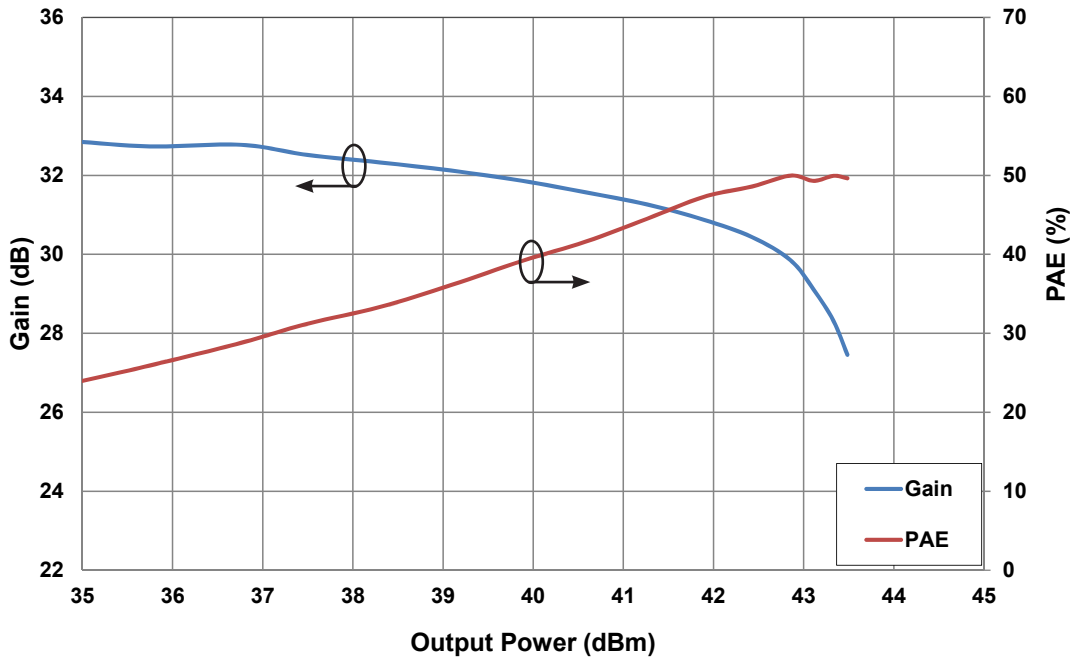


**Figure 4. - Gain and Power Added Efficiency vs Output Power  
Measured in CMPA2735015S-AMP1 Amplifier Circuit  
 $V_{DD} = 50\text{ V}$ ,  $I_{DQ} = 0.08\text{ A}$ , Frequency = 3.1 GHz**



## Typical Performance of the CMPA2735015S

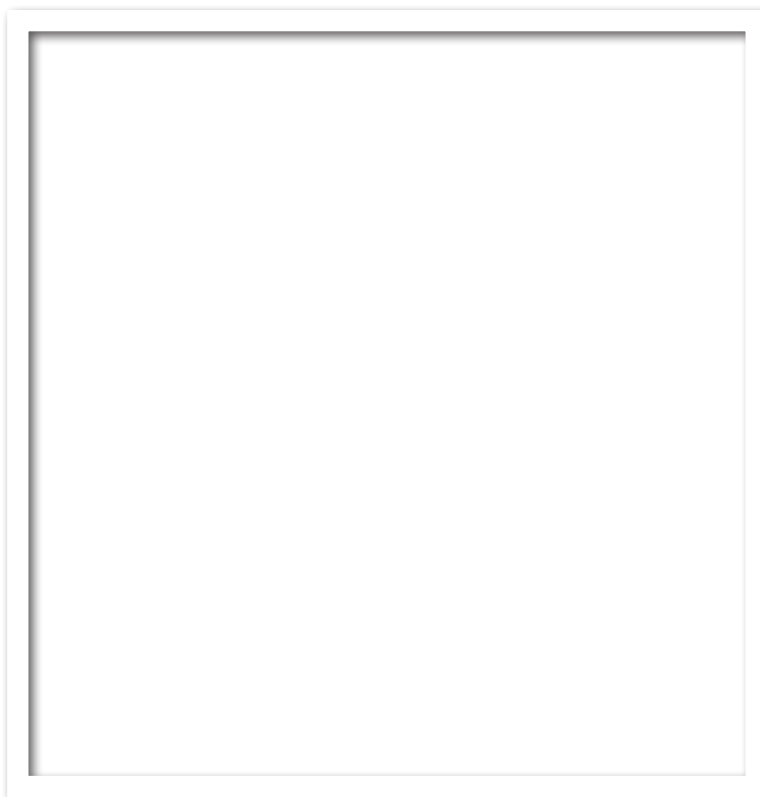
Figure 5. - Gain and Power Added Efficiency vs Output Power  
 Measured in CMPA2735015S-AMP1 Amplifier Circuit  
 $V_{DD} = 50\text{ V}$ ,  $I_{DQ} = 0.08\text{ A}$ , Frequency = 3.5 GHz



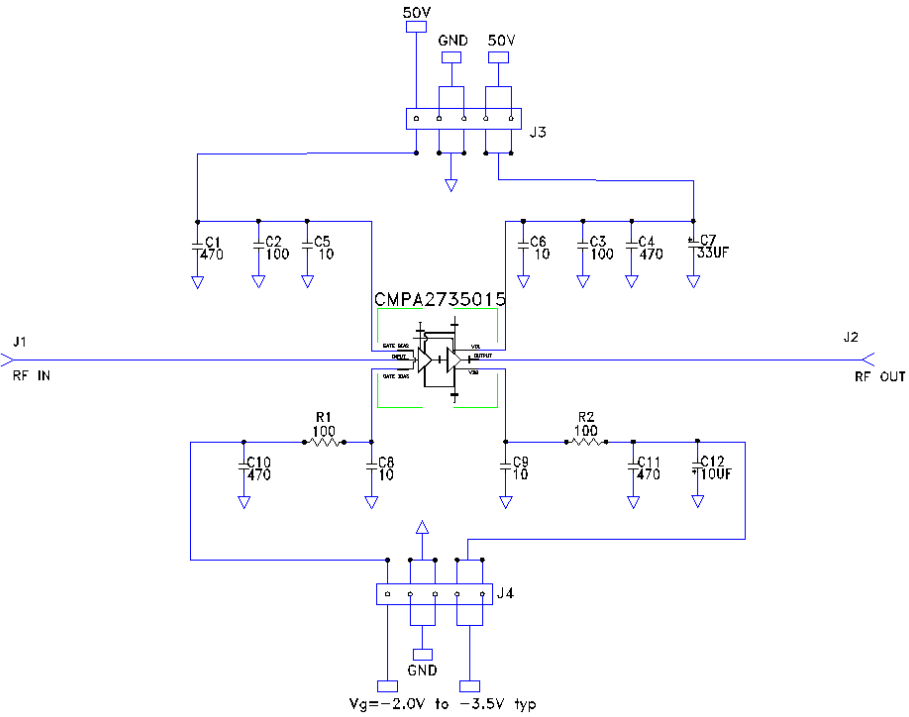
## CMPA2735015S-AMP1 Demonstration Amplifier Circuit Bill of Materials

Designator	Description	Qty
C1, C4, C10, C11	CAP, 470pF, 100V, 0603	1
C2, C3	CAP, 100pF, 100V, 0603	1
C5, C6, C8, C9	CAP, 10pF, 100V, 0402	1
C7	CAP, 33uF, 50V, ELECT, MVY, SMD	1
C12	CAP, 10uF, 16V, TANTALUM, SMD	1
R1, R2	RES, 100Ohm, 1/16W, 0603	2
J1, J2	CONNECTOR, N-TYPE, FEMALE, W/0.500 SMA FLNG	1
J3, J4	CONNECTOR, HEADER, RT>PLZ .1CEN LK 5POS	1
-	PCB, RO4350B, E <sub>g</sub> = 3.48, h = 10 mil	1
Q1	CMPA2735015S	1

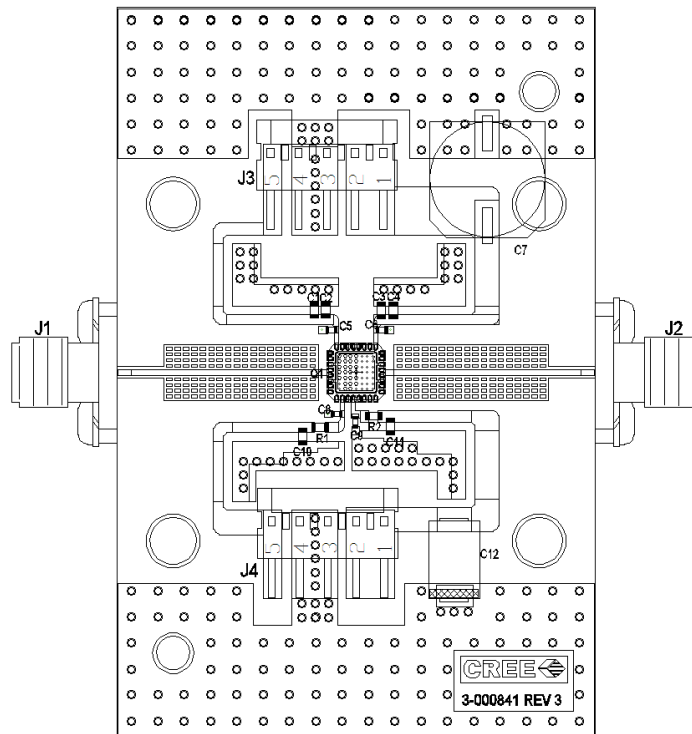
## CMPA2735015S-AMP1 Demonstration Amplifier Circuit



## CMPA2735015S-AMP1 Demonstration Amplifier Circuit Schematic

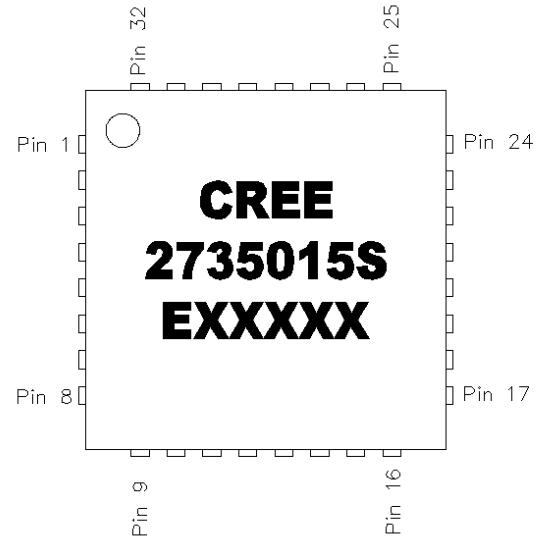


## CMPA2735015S-AMP1 Demonstration Amplifier Circuit Outline



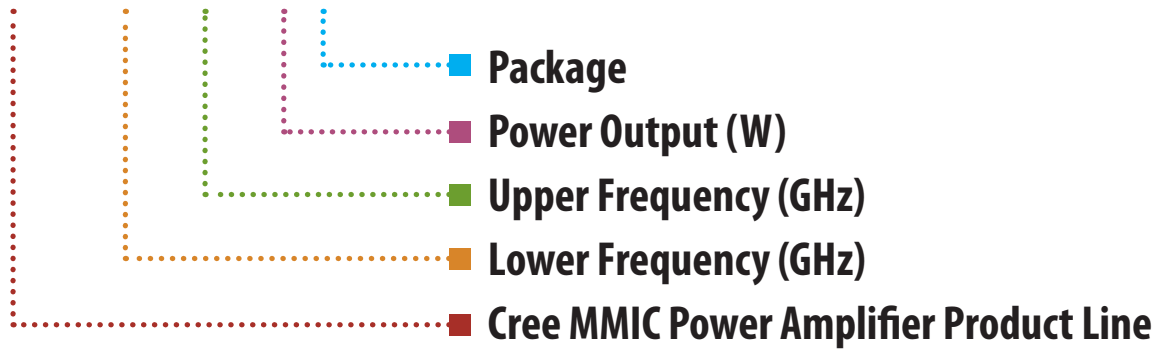
## Product Dimensions CMPA2735015S (Package )

Pin	Input/Output
1,2,3	NC
4	RF IN
5	RF IN
6,7,8,9	NC
10	VG1
11	NC
12	VG2
13,14,15,16	NC
17,18,19	NC
20	RF OUT
21	RF OUT
22,23,24	NC
25	VD2
26,27,28,29	NC
30,31	NC
32	VD1





# CMPA2735015S



Parameter	Value	Units
Lower Frequency	2.7	GHz
Upper Frequency	3.5	GHz
Power Output	15	W
Package	Surface Mount	-

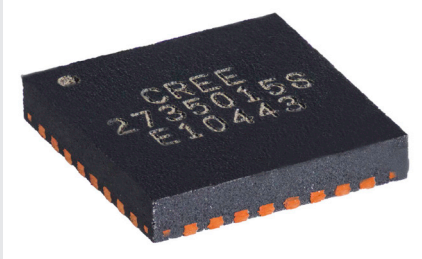
Table 1.

**Note:** Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Character Code	Code Value
A	0
B	1
C	2
D	3
E	4
F	5
G	6
H	7
J	8
K	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz

Table 2.

## Product Ordering Information

Order Number	Description	Unit of Measure	Image
CMPA2735015S	GaN HEMT	Each	
CMPA2735015S-AMP1	Test board with GaN MMIC installed	Each	



## Disclaimer

Specifications are subject to change without notice. Cree, Inc. believes the information contained within this data sheet to be accurate and reliable. However, no responsibility is assumed by Cree for its use or for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Cree. Cree makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose. "Typical" parameters are the average values expected by Cree in large quantities and are provided for information purposes only. These values can and do vary in different applications, and actual performance can vary over time. All operating parameters should be validated by customer's technical experts for each application. Cree products are not designed, intended, or authorized for use as components in applications intended for surgical implant into the body or to support or sustain life, in applications in which the failure of the Cree product could result in personal injury or death, or in applications for the planning, construction, maintenance or direct operation of a nuclear facility. CREE and the CREE logo are registered trademarks of Cree, Inc.

For more information, please contact:

Cree, Inc.  
4600 Silicon Drive  
Durham, North Carolina, USA 27703  
[www.cree.com/RF](http://www.cree.com/RF)

Sarah Miller  
Marketing  
Cree, RF Components  
1.919.407.5302

Ryan Baker  
Marketing & Sales  
Cree, RF Components  
1.919.407.7816

Tom Dekker  
Sales Director  
Cree, RF Components  
1.919.407.5639